

(1.00 mm) .0394"

PCIE-036-02-F-D-TH **PCIE SERIES**

PCI EXPRESS® CARD SOCK

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?PCIE

Insulator Material:

-TH=Black Nylon -EMS2 & -RA=LCP Contact:

Phosphor Bronze

Plating: Au or Sn over 50 µ" (1.27 µm) Ni Current Rating: 2.2 A per pin (2 adjacent pins powered)
Operating Temp:
-55 °C to +125 °C

Card Insertion Depth: (7.65 mm) .301" nominal RoHS Compliant:

Lead-Free Solderable: -RA & -EMS2=Yes

-TH=Wave only

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



OTHER SOLUTIONS

PCI Express® Jumpers & Extenders call for PCIEC Series



- · Loop back Extender (From one PCIe® slot to another PCIe® slot)
- Ser-Des Physical Extender (From one PCIe® slot to another PCIe® Ser-Des)
- Physical Extender for easy troubleshooting of PCIe® card debug and analysis (PCIe® slot to Emulator or Analyzer)

Contact Samtec.

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Some lengths, styles and options are non-standard, non-returnable.

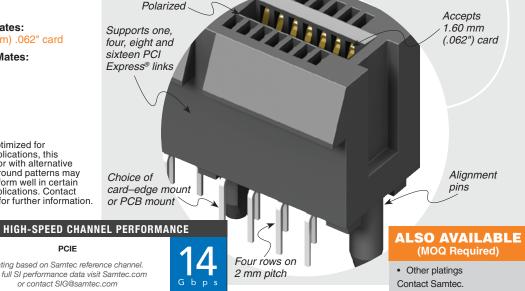
Card Mates:

1.60 mm) .062" card

Cable Mates:

While optimized for 50 Ω applications, this connector with alternative signal/ground patterns may also perform well in certain 75 Ω applications. Contact Samtec for further information.

PCIE



-036, -064, -098, -164

NO. OF

POSITIONS

Rating based on Samtec reference channel. For full SI performance data visit Samtec.com or contact SIG@samtec.com

PLATING OPTION

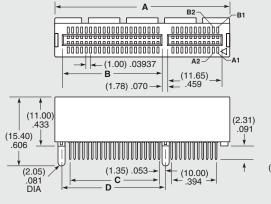
TAIL OPTION

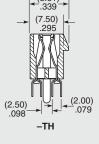
–F

= Gold flash on contact, Tin on tail

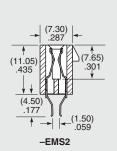
= Edge Mount _TH = Through-hole -RA = Right-angle

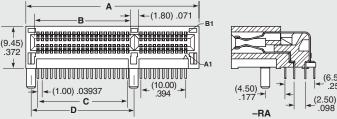
-EMS2





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POSITIONS	Α	В	С	D
-036 (X1)	(25.00)	(7.65)	(6.00)	(9.15)
	.984	.301	.236	.360
-064 (X4)	(39.00) 1.535	(21.65) .852	(20.00) .787	(23.15)
-098 (X8)	(56.00)	(38.65)	(37.00)	(40.15)
	2.205	1.522	1.457	1.581
-164 (X16)	(89.00)	(71.65)	(70.00)	(73.15)
	3.504	2.821	2.756	2.880

Due to technical progress, all designs, specifications and components are subject to change without notice